TAIWAN SEMICONDUCTOR

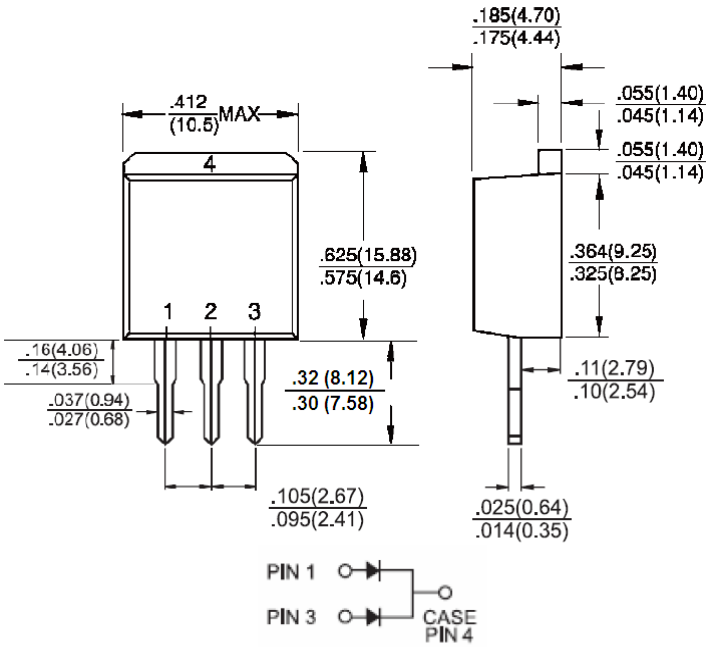
MBRI20100CT

20.0AMPS Schottky Barrier Rectifier

I^2PAK

RoHS COMPLIANCE





Features

- ✧ Plastic material used carries Underwriters Laboratory Classifications 94V-0
- ✧ Metal silicon junction, majority carrier conduction
- ✧ Low power loss, high efficiency
- ✧ High current capability, low forward voltage drop
- ✧ High Surge capability
- ✧ For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- ✧ Guarding for over voltage protection
- ✧ High temperature soldering guaranteed: 260℃/ 10 seconds at terminals
- ✧ Green compound with suffix "G" on packing code & prefix "G" on datecode

Mechanical Data

- ✧ Case: JEDEC I^2PAK molded plastic
- ✧ Terminals: Leads solderable per MIL-STD-750, Method 2026
- ✧ Polarity: As marked
- ✧ Mounting position: Any
- ✧ Weight: 1.41 grams

Dimensions in inches and (millimeters)

Marking Diagram



MBRI20100CT	= Specific Device Code
G	= Green compound
Y	= Year
WW	= Work Week

Maximum Ratings and Electrical Characteristics

Rating at 25 ℃ ambient temperature unless otherwise specified.
Single phase, half wave, 60 Hz, resistive or inductive load.
For capacitive load, derate current by 20%

Type Number	Symbol	MBRI20100CT	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100	V
Maximum RMS Voltage	V_{RMS}	70	V
Maximum DC blocking voltage	V_{DC}	100	V
Maximum Average Forward Rectified Current @Tc = 130℃(Total Device)	$I_{F(AV)}$	20	A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	150	A
Maximum Instantaneous Forward Voltage at (Note 1) I_F = 10A, T_A=25℃ I_F = 10A, T_A=125℃ I_F = 20A, T_A=25℃ I_F = 20A, T_A=125℃	V_F	 0.85 0.75 0.95 0.85	V
Maximum Reverse Current T_A=25 ℃ T_A=125 ℃	I_R	 0.1 5	 mA mA
Voltage rate of change (Rated V_R)	dV/dt	10,000	V/uS
Maximum Thermal Resistance Per Leg (Note 2)	$R_{\theta JC}$	2	$^OC/W$
Operating Temperature Range	T_J	-65 to + 150	^OC
Storage Temperature Range	T_{STG}	-65 to + 175	^OC

Note1: Pulse Test : 300us Pulse Width, 1% Duty cycle

Note2: Thermal Resistance from Junction to Case Per Leg

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RATINGS AND CHARACTERISTIC CURVES (MBRI20100CT)

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

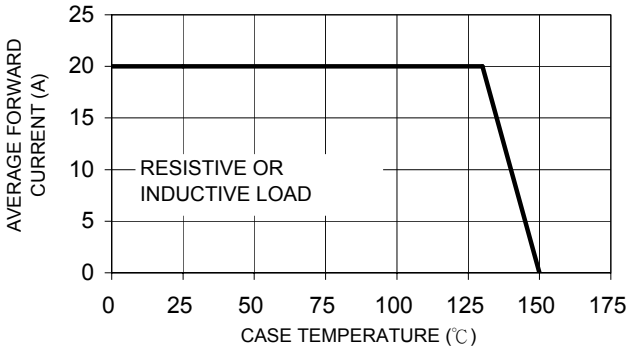


FIG. 2 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT PER LEG

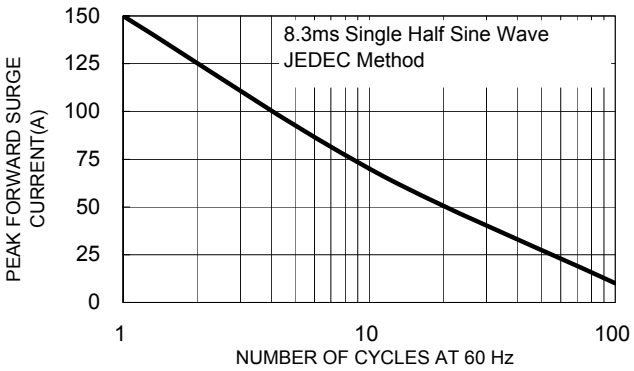


FIG. 3 TYPICAL FORWARD CHARACTERISTICS PER LEG

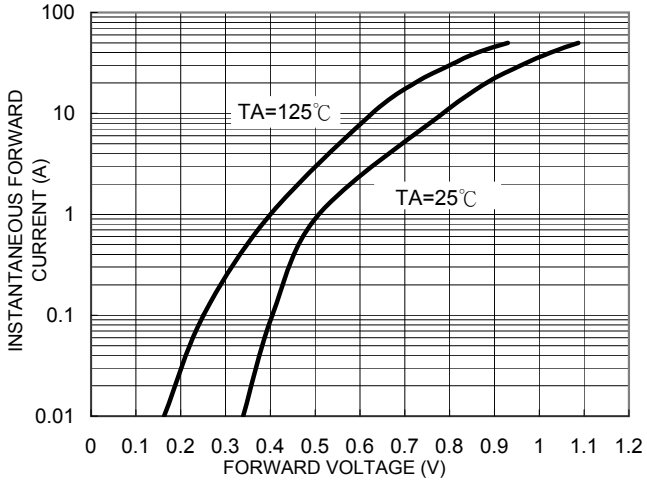


FIG. 4 TYPICAL REVERSE CHARACTERISTICS PER LEG

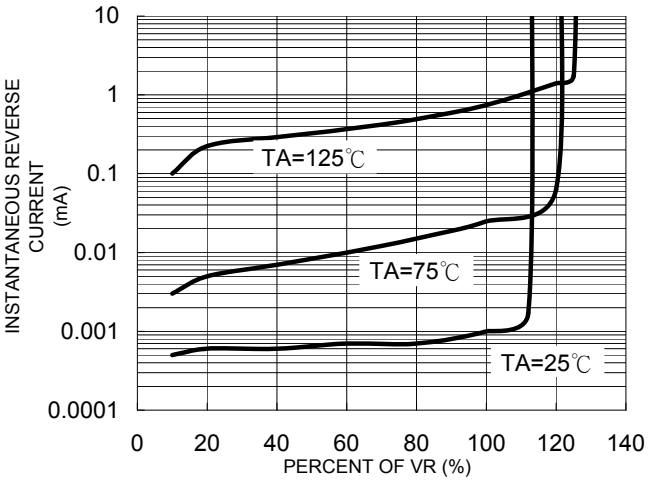


FIG. 5 TYPICAL JUNCTION CAPACITANCE

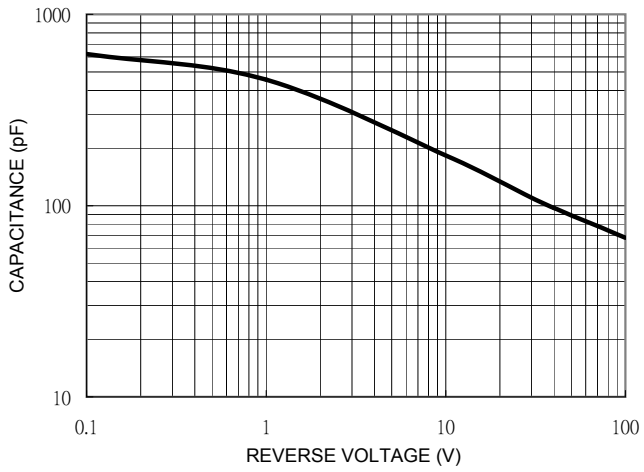


FIG. 6 TYPICAL TRANSIENT THERMAL IMPEDANCE PER LEG

